

# LM8364 Micropower Undervoltage Sensing Circuits

Check for Samples: LM8364

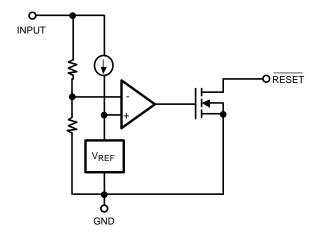
## **FEATURES**

- Extremely Low Quiescent Current: 0.65µA, at  $V_{IN} = 2.87V$
- High Accuracy Threshold Voltage (±2.5%)
- **Open Drain Output**
- Input Voltage Range: 1V to 6V
- **Surface Mount Package (5-Pin SOT-23)**
- Pin for Pin Compatible with MC33464

### **APPLICATIONS**

- **Low Battery Detection**
- **Microprocessor Reset Controller**
- **Power Fail Indicator**
- **Battery Backup Detection**

## **Functional Block Diagram**



## DESCRIPTION

The LM8364 series are micropower undervoltage sensing circuits that are ideal for use in battery powered microprocessor based systems, where extended battery life is a key requirement.

A range of threshold voltages from 2.0V to 4.5V are available with an active low open drain output. These devices feature a very low quiescent current of 0.65µA typical. The LM8364 series features a highly accurate voltage reference, a comparator with precise thresholds and built-in hysterisis to prevent erratic reset operation, and ensured Reset operation down to 1.0V with extremely low standby current.

These devices are available in the space saving SOT-23 5-pin surface mount package. For other undervoltage thresholds and output options, please contact Texas Instruments.

## **Connection Diagram**

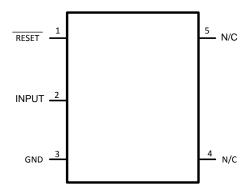


Figure 1. 5-Pin SOT-23 **Top View** 

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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## Absolute Maximum Ratings (1)(2)

Supply Voltage		-0.3V to 6.5V				
RESET Output Voltage	RESET Output Voltage					
RESET Output Current		70mA				
Storage Temperature Range		−65°C to 150°C				
Mounting Temp.	Lead Temp (Soldering, 10 sec)	260°C				
Junction Temperature		125°				

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications and the test conditions, see the Electrical Characteristics.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.

## Operating Ratings (1)

Temperature Range	-40°C to 85°C
Thermal Resistance to ambient $(\theta_{JA})$	265°C/W
ESD Tolerance	
Human Body Model	2000V
Machine Model	200V

<sup>(1)</sup> Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications and the test conditions, see the Electrical Characteristics.

#### **Electrical Characteristics**

Unless otherwise specified, all limits ensured for  $T_A = 25$ °C.

Symbol	Parameter	Conditions	<b>Min</b> (1)	<b>Typ</b> (2)	Max (1)	Units
V <sub>DET</sub> -	Detector Threshold Voltage	High to Low State Output (V <sub>IN</sub> Decreasing)				
		20 Suffix	1.950	2.0	2.050	
		27 Suffix	2.633	2.7	2.767	V
		30 Suffix	2.925	3.0	3.075	
		32 Suffix	3.120	3.2	3.280	
		45 Suffix	4.388	4.5	4.613	
V <sub>HYS</sub>	Detector Threshold Hysteresis	V <sub>IN</sub> Increasing				
		20 Suffix	0.060	0.100	0.140	
		27 Suffix	0.081	0.135	0.189	V
		30 Suffix	0.090	0.150	0.210	V
		32 Suffix	0.096	0.160	0.224	
		45 Suffix	0.135	0.225	0.315	
ΔVdet/ΔT	Detector Threshold Voltage Temperature Coefficient			±100		PPM/°C
V <sub>OL</sub>	RESET Output Voltage Low State	(Open Drain Output: I <sub>SINK</sub> = 1mA)		0.25	0.5	V
I <sub>OL</sub>	RESET Output Sink Current	V <sub>IN</sub> = 1.5V, V <sub>OL</sub> = 0.5V	1.0	2.5		mA
V <sub>IN</sub>	Operating Input Voltage Range		1.0		6.0	V

(1) All limits are ensured by testing or statistical analysis.

(2) Typical values represent the most likely parametric norm

Product Folder Links: LM8364



## **Electrical Characteristics (continued)**

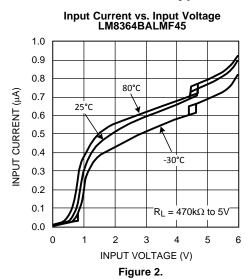
Unless otherwise specified, all limits ensured for  $T_A$  = 25°C.

Symbol	Parameter	Conditions	<b>Min</b> (1)	Typ (2)	Max (1)	Units
I <sub>IN</sub>	Quiescent Input Current	20 Suffix				
		V <sub>IN</sub> = 1.9V		0.55	0.8	
		V <sub>IN</sub> = 4.0V		0.70	1.3	
		27 Suffix				
		V <sub>IN</sub> = 2.6V		0.62	0.9	
		V <sub>IN</sub> = 4.7V		0.75	1.3	
		30 Suffix				
		V <sub>IN</sub> = 2.87V		0.65	0.9	μΑ
		V <sub>IN</sub> = 5.0V		0.77	1.3	
		32 Suffix				
		V <sub>IN</sub> = 3.08V		0.66	0.9	
		V <sub>IN</sub> = 5.20V		0.79	1.3	
		45 Suffix				
		V <sub>IN</sub> = 4.34V		0.70	1.0	
		V <sub>IN</sub> = 6.0		0.85	1.4	
t <sub>p</sub>	Propagation Delay Time Figure 7			60	300	μs

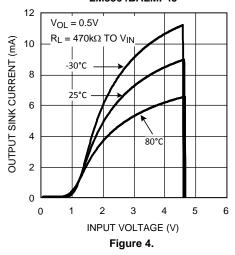
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## **Typical Performance Characteristics**



# Reset Output Sink Current vs. Input Voltage LM8364BALMF45



#### Reset Output Voltage vs. Input Voltage LM8364BALMF45

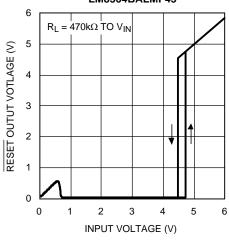
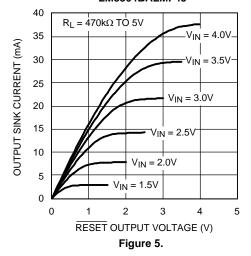


Figure 3.

# Reset Output Sink Current vs. Output Voltage LM8364BALMF45



# Detector Threshold Voltage vs. Temperature LM8364BALMF45

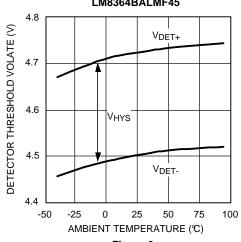


Figure 6.



#### **APPLICATION NOTES**

The propagation delay time for the LM8364 is measured using a 470k $\Omega$  pull-up resistor connected to from the RESET output pin to 5V in addition to a 10pF capacitive load connected from the same pin to GND. Figure 7 shows the timing diagram for the measurement for the propagation delay.  $V_{DET+}$  is equal to the sum of the detector threshold,  $V_{DET-}$ , and the built in hysteresis,  $V_{HYS}$ .

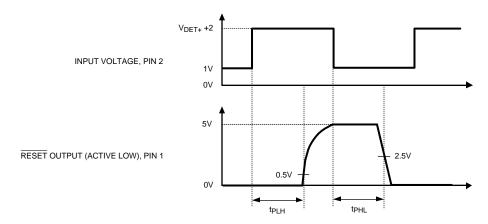


Figure 7. Propagation Delay Timing Diagrams

The LM8364 ultra-low current voltage detector was designed to monitor voltages and to provide an indication when the monitored voltage,  $V_{IN}$ , dropped below a precisely trimmed threshold voltage. This characteristic is displayed in the typical operating timing diagram below.  $V_{IN}$  is the voltage that is being monitored and a pull up resistor is connected from the RESET output pin to  $V_{IN}$ .  $V_{IN}$  is at some value above  $V_{DET+}$  and then begins to decrease. Since this is an Active Low device the RESET output is pulled High through the pull-up resistor and tracks  $V_{IN}$  until  $V_{IN}$  crosses the trimmed threshold  $V_{DET-}$ . At this point the LM8364 recognizes that  $V_{IN}$  is now in a fault condition and the output immediately changes to the Logic Low State. The RESET output will remain in this low state until  $V_{IN}$  increases above the threshold  $V_{DET-} + V_{HYS}$ . This point is also known as  $V_{DET+}$  as indicated earlier. This built-in hysteresis has been added to the design to help prevent erratic reset operation when the input voltage crosses the threshold.

The LM8364 has a wide variety of applications that can take advantage of its precision and low current consumption to monitor Input voltages even though it was designed as a reset controller in portable microprocessor based systems. It is a very cost effective and space saving device that will protect your more expensive investments of microprocessors and other devices that need a specified supply voltage for proper operation.

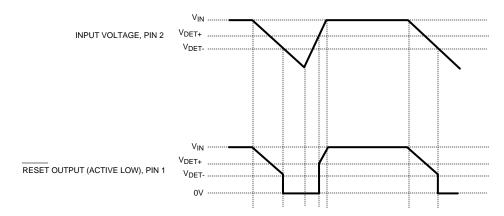


Figure 8. Timing Waveforms

Product Folder Links: LM8364



## **Typical Applications**

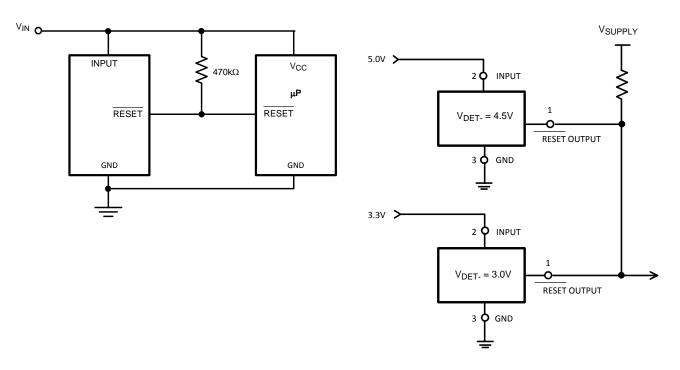
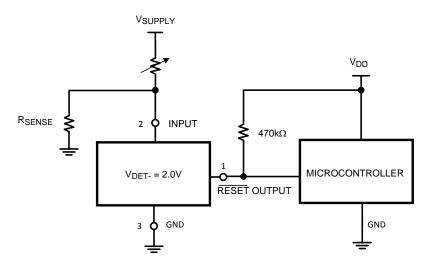


Figure 9. Microprocessor Reset Circuit

Figure 10. Dual Power Supply Undervoltage Supervision



THIS CIRCUIT MONITORS THE CURRENT AT THE LOAD. AS CURRENT FLOW THROUGH THE LOAD, A VOLTAGE DROP WITH RESPECT TO GROUND APPEARS ACROSS R<sub>SENSE</sub> WHERE V<sub>SENSE</sub> = I<sub>LOAD</sub> \* R<sub>SENSE</sub>. THE FOLLOWING CONDITIONS APPLY:

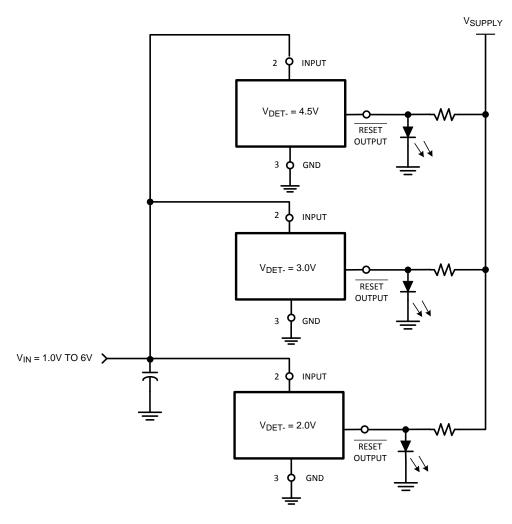
IF: THEN:

Figure 11. Microcontroller System Load Sensing

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EACH LED WILL SEQUENTIALLY TURN ON WHEN THE RESPECTIVE VOLTAGE DETECTOR THRESHOLD (VDET- +VHYS) IS EXCEEDED.

Figure 12. LED Bar Graph Voltage Monitor



## **REVISION HISTORY**

Cł	Changes from Revision A (April 2013) to Revision B							
•	Changed layout of National Data Sheet to TI format	7	7					

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#### PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
LM8364BALMF20	LIFEBUY	SOT-23	DBV	5	1000	Non-RoHS & Green	Call TI	Level-1-260C-UNLIM	-40 to 85	F01A	
LM8364BALMF20/NOPB	ACTIVE	SOT-23	DBV	5	1000	RoHS & Green	SN	Level-1-260C-UNLIM	-40 to 85	F01A	Samples
LM8364BALMFX20/NOPB	ACTIVE	SOT-23	DBV	5	3000	RoHS & Green	SN	Level-1-260C-UNLIM	-40 to 85	F01A	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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# **PACKAGE OPTION ADDENDUM**

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## **PACKAGE MATERIALS INFORMATION**

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## TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM8364BALMF20	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LM8364BALMF20/NOPB	SOT-23	DBV	5	1000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
LM8364BALMFX20/NOPB	SOT-23	DBV	5	3000	178.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3

# **PACKAGE MATERIALS INFORMATION**

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## \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM8364BALMF20	SOT-23	DBV	5	1000	208.0	191.0	35.0
LM8364BALMF20/NOPB	SOT-23	DBV	5	1000	208.0	191.0	35.0
LM8364BALMFX20/NOPB	SOT-23	DBV	5	3000	208.0	191.0	35.0



SMALL OUTLINE TRANSISTOR



## NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.
  3. Reference JEDEC MO-178.

- 4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
- 5. Support pin may differ or may not be present.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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